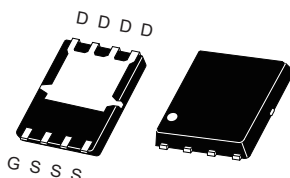


P-Channel Enhancement Mode Field Effect Transistor

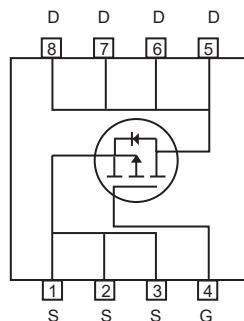
PRELIMINARY

FEATURES

- -200V, -12.5A, $R_{DS(ON)} = 0.36\Omega$ @ $V_{GS} = -10V$.
- Super high dense cell design for extremely low $R_{DS(ON)}$.
- High power and current handling capability.
- RoHS compliant.
- Surface mount Package.



P-PAK 5X6



ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	V_{DS}	-200	V
Gate-Source Voltage	V_{GS}	± 30	V
Drain Current-Continuous	$I_D @ R_{\theta JC}$	-12.5	A
Drain Current-Continuous	$I_D @ R_{\theta JA}$	-3.2	A
Drain Current-Pulsed ^a	$I_{DM} @ R_{\theta JC}$	-50	A
Drain Current-Pulsed ^a	$I_{DM} @ R_{\theta JA}$	-12.8	A
Maximum Power Dissipation	P_D	96	W
Single Pulsed Avalanche Energy ^e	E_{AS}	165	mJ
Single Pulsed Avalanche Current ^e	I_{AS}	10.5	A
Operating and Store Temperature Range	T_J, T_{stg}	-55 to 150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.3	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Ambient ^b	$R_{\theta JA}$	20	$^\circ\text{C/W}$

This is preliminary information on a new product in development now .
Details are subject to change without notice .

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<http://www.cet-mos.com>

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0V, I_D = -250\mu A$	-200			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -200V, V_{GS} = 0V$			-1	μA
Gate Body Leakage Current, Forward	I_{GSSF}	$V_{GS} = 30V, V_{DS} = 0V$			100	nA
Gate Body Leakage Current, Reverse	I_{GSSR}	$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
On Characteristics ^c						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS} = V_{DS}, I_D = -250\mu A$	-2		-4	V
Static Drain-Source	$R_{DS(on)}$	$V_{GS} = -10V, I_D = -5.2A$		0.28	0.36	Ω
On-Resistance						
Dynamic Characteristics ^d						
Input Capacitance	C_{iss}	$V_{DS} = -25V, V_{GS} = 0V, f = 1.0\text{ MHz}$		1620		pF
Output Capacitance	C_{oss}			240		pF
Reverse Transfer Capacitance	C_{rss}			50		pF
Switching Characteristics ^d						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -100V, I_D = -13.5A, V_{GS} = -10V, R_{GEN} = 25\Omega$		28		ns
Turn-On Rise Time	t_r			74		ns
Turn-Off Delay Time	$t_{d(off)}$			260		ns
Turn-Off Fall Time	t_f			120		ns
Total Gate Charge	Q_g	$V_{DD} = -160V, I_D = -13.5A, V_{GS} = -10V$		52		nC
Gate-Source Charge	Q_{gs}			9		nC
Gate-Drain Charge	Q_{gd}			25		nC
Drain-Source Diode Characteristics and Maximum Ratings						
Drain-Source Diode Forward Current ^b	I_S				-12.5	A
Drain-Source Diode Forward Voltage ^c	V_{SD}	$V_{GS} = 0V, I_S = -12.5A$			-1.2	V
Notes : a.Repetitive Rating : Pulse width limited by maximum junction temperature. b.Surface Mounted on FR4 Board, $t \leq 10\text{ sec}$. c.Pulse Test : Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$. d.Guaranteed by design, not subject to production testing. e.L = 3mH, $I_{AS} = 10.5A, V_{DD} = 25V, R_G = 25\Omega$, Starting $T_J = 25^\circ C$.						

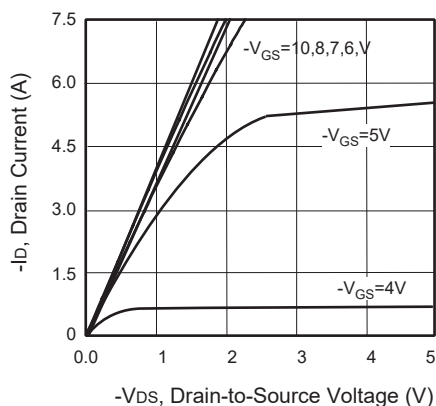


Figure 1. Output Characteristics

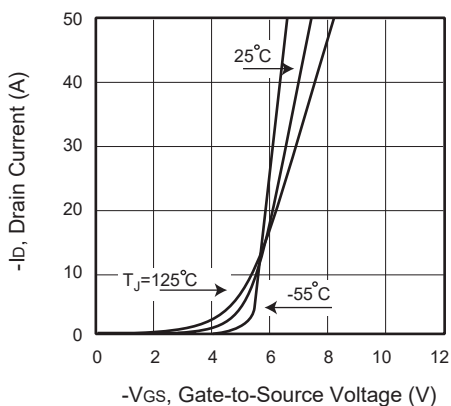


Figure 2. Transfer Characteristics

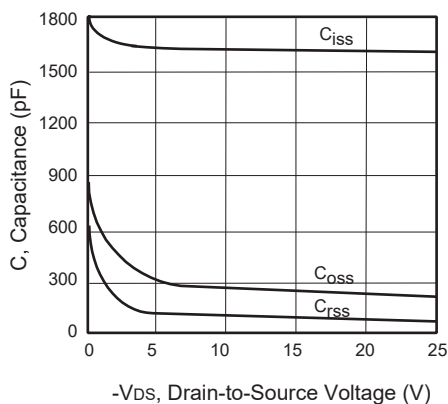


Figure 3. Capacitance

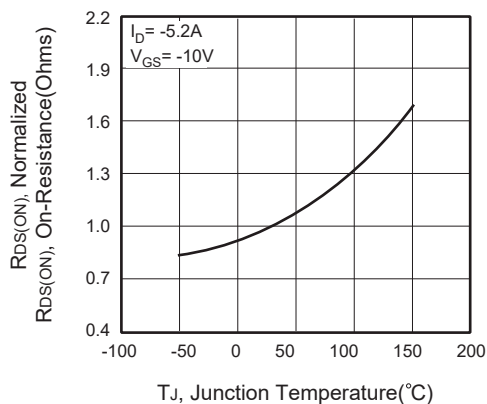


Figure 4. On-Resistance Variation with Temperature

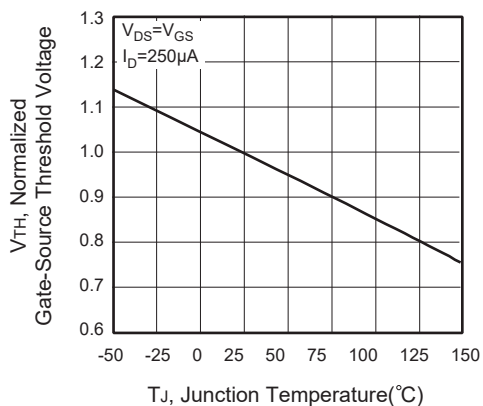


Figure 5. Gate Threshold Variation with Temperature

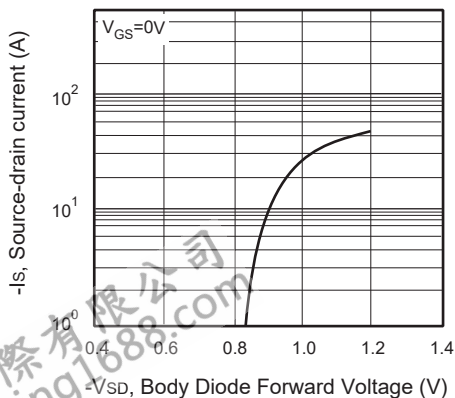


Figure 6. Body Diode Forward Voltage Variation with Source Current

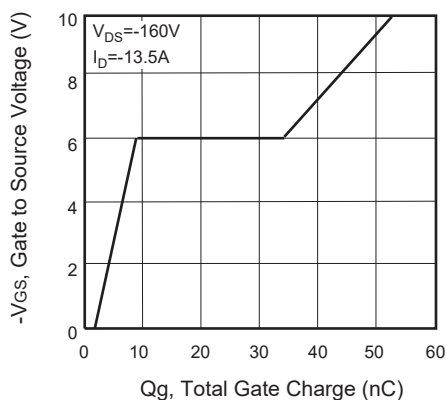


Figure 7. Gate Charge

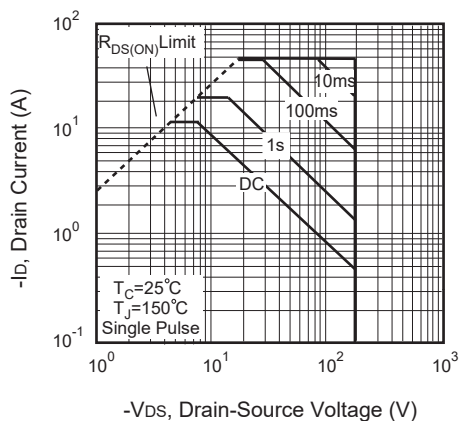


Figure 8. Maximum Safe Operating Area

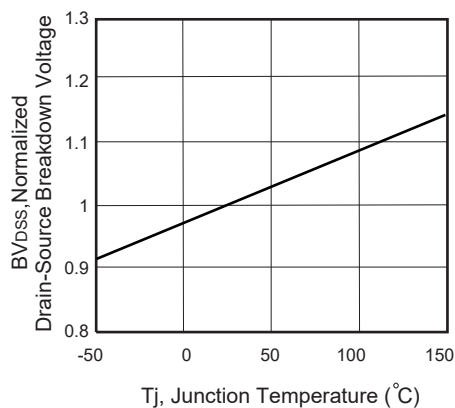


Figure 9. Breakdown Voltage Variation VS Temperature

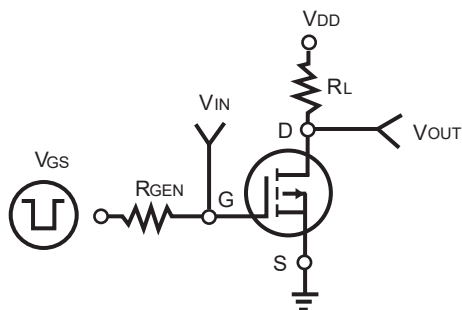


Figure 10. Switching Test Circuit

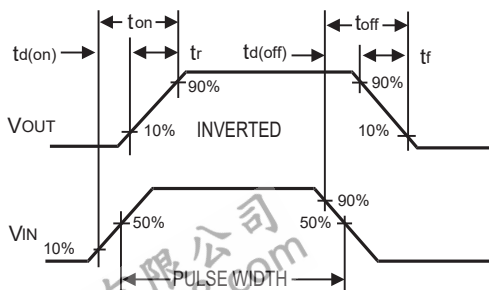


Figure 11. Switching Waveforms

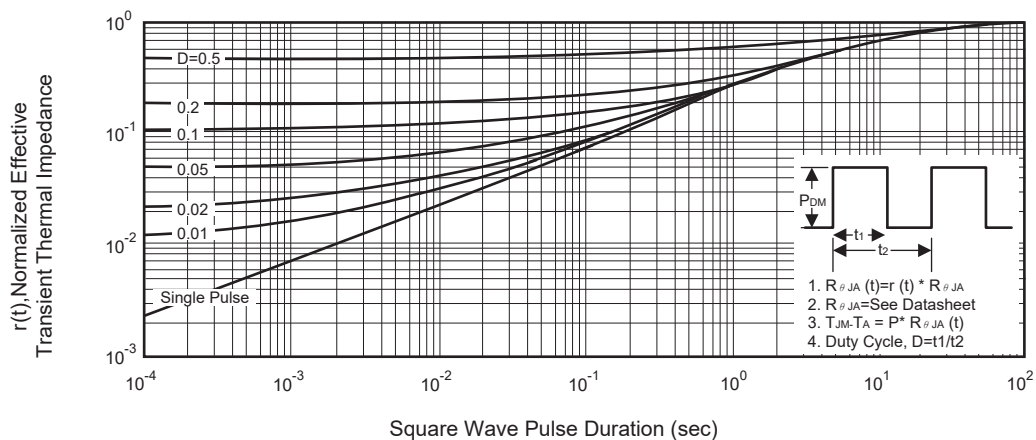
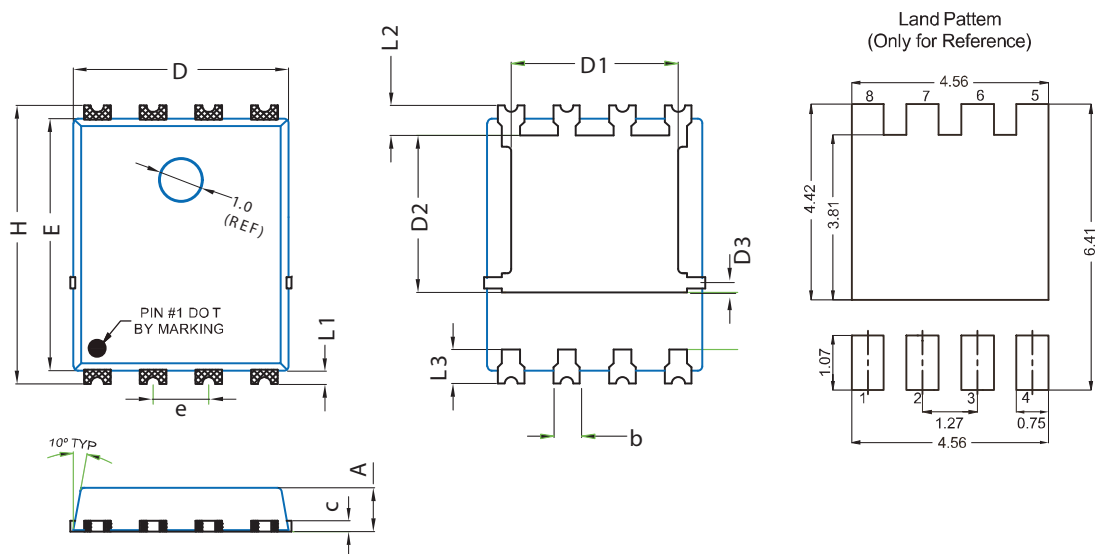


Figure 11. Normalized Thermal Transient Impedance Curve

P-PAK5X6 產品外觀尺寸圖 (Product Outline Dimension)

SINGLE PAD 尺寸圖



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.900	1.100	0.035	0.043
b	0.520	0.750	0.020	0.030
c	0.20	0.30	0.008	0.012
D	4.800	5.000	0.189	0.197
D1	3.610	3.960	0.142	0.156
D2	3.380	3.780	0.133	0.149
D3	0.200	0.300	0.008	0.012
E	5.700	5.800	0.224	0.228
e	1.270 TYP		0.050 TYP	
H	6.250	6.450	0.246	0.254
L1	0.250	0.400	0.010	0.016
L2	0.580	0.780	0.023	0.031
L3	0.680	0.880	0.027	0.035